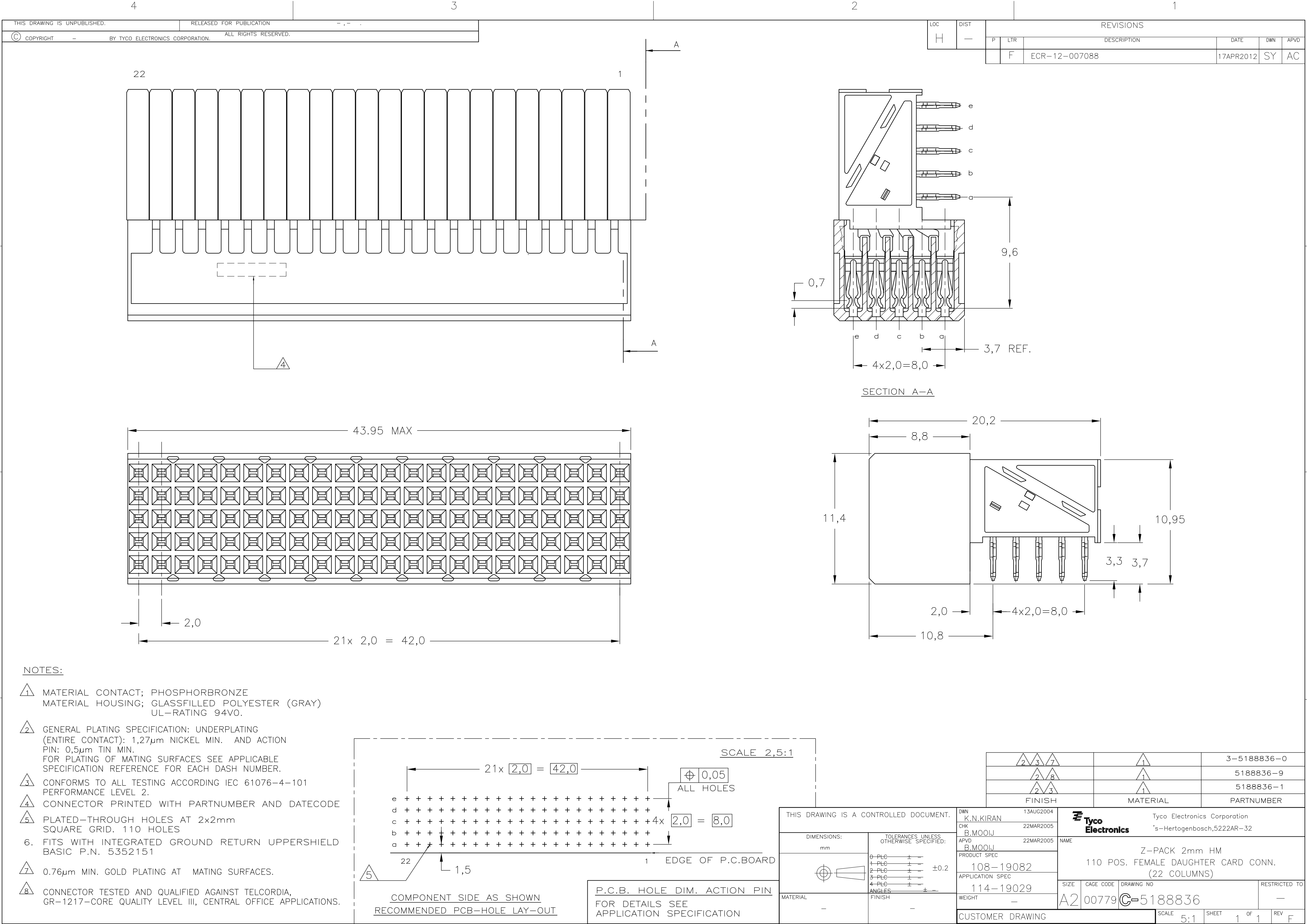




NOTES:

- 1 MATERIAL CONTACT; PHOSPHORBRONZE
MATERIAL HOUSING; GLASSFILLED POLYESTER (GRAY)
UL-RATING 94V0.
- 2 GENERAL PLATING SPECIFICATION: UNDERPLATING
(ENTIRE CONTACT): 1,27µm NICKEL MIN. AND ACTION
PIN: 0,5µm TIN MIN.
FOR PLATING OF MATING SURFACES SEE APPLICABLE
SPECIFICATION REFERENCE FOR EACH DASH NUMBER.
- 3 CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101
PERFORMANCE LEVEL 2.
- 4 CONNECTOR PRINTED WITH PARTNUMBER AND DATECODE
- 5 PLATED-THROUGH HOLES AT 2x2mm
SQUARE GRID. 110 HOLES
- 6. FITS WITH INTEGRATED GROUND RETURN UPPERSHIELD
BASIC P.N. 5352151
- 7 0.76µm MIN. GOLD PLATING AT MATING SURFACES.
- 8 CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA,
GR-1217-CORE QUALITY LEVEL III, CENTRAL OFFICE APPLICATIONS.